

P-Channel 100-V (D-S) MOSFET

| PRODU | CT SUMMARY | | |
|---------------------|-----------------------------------|--------------------|-----------------------|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ.) |
| - 100 | 0.200 at V _{GS} = - 10 V | - 3.0 | 13.2 nC |
| - 100 | 0.230 at V _{GS} = - 6 V | - 2.4 | 13.2110 |

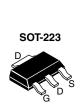
FEATURES

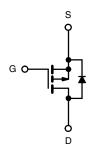
- TrenchFET[®] Power MOSFET
- 100% R_q and UIS Tested

RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Active Clamp in Intermediate DC/ DC Power Supplies
- H-Bridge High Side Switch for Lighting Application





P-Channel MOSFET

| Parameter | Symbol | Limit | Unit | |
|---|-----------------------------------|------------------|-----------------------|----|
| Drain-Source Voltage | | V _{DS} | - 100 | V |
| Gate-Source Voltage | | V _{GS} | ± 20 | v |
| | T _C = 25 °C | | - 3.0 | |
| Continuous Drain Current (T _{.I} = 150 °C) | T _C = 70 °C | | -2.1 | |
| Continuous Diain Current (1) = 130 C) | T _A = 25 °C | I _D | - 2 ^{a, b} | |
| | T _A = 70 °C | | - 1.6 ^{a, b} | A |
| Pulsed Drain Current | | I _{DM} | - 12 | ^ |
| Continuous Source-Drain Diode Current | T _C = 25 °C | 1- | - 4.9 | |
| Continuous Source-Diain Diode Current | T _A = 25 °C | - I _S | - 2.5 ^{a, b} | |
| Avalanche Current L = 0.1 n | | I _{AS} | - 15 | |
| Single-Pulse Avalanche Energy | | E _{AS} | 11.25 | mJ |
| | T _C = 25 °C | | 6.5 | |
| Maximum Power Dissipation | T _C = 70 °C | P _D | 4.8 | w |
| Maximum Fower Dissipation | T _A = 25 °C | 'D | 3.1 ^{a, b} | VV |
| | T _A = 70 °C | | 2 ^{a, b} | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.

| THERMAL RESISTANCE RATINGS | | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{a, b} | t ≤ 10 s | R _{thJA} | 33 | 40 | °C/W | | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 17 | 21 | C/VV | | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Maximum under steady state conditions is 80 $^{\circ}\text{C/W}.$

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|---|-------|-------|-------|--------|
| Static | | | | • | • | • |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$ | - 100 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μA | | - 165 | | m\//°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | η η = - 250 μΑ | | - 6.6 | | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 2 | | - 4 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | lace | V _{DS} = - 100 V, V _{GS} = 0 V | | | - 1 | |
| Zero Gate Voltage Drain Gurrent | I _{DSS} | V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 55 °C | | | - 10 | μΑ |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$ | - 8 | | | Α |
| Drain-Source On-State Resistance ^a | B | V _{GS} = - 10 V, I _D = - 3 A | 0.200 | | | |
| | R _{DS(on)} | $V_{GS} = -6 \text{ V}, I_D = -2 \text{ A}$ | | 0.230 | | Ω |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = 3 A | | 12 | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | | | 819 | | |
| Output Capacitance | C _{oss} | $V_{DS} = -35 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 51 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 32 | | |
| Total Cata Charge | Qg | $V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3 \text{ A}$ | | 17.5 | 32 | ,,, |
| Total Gate Charge | | | | 13.2 | 25 | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = -50 \text{ V}, V_{GS} = -6 \text{ V}, I_{D} = -3 \text{ A}$ | | 3.4 | | nC |
| Gate-Drain Charge | Q _{gd} | | | 6.4 | | |
| Gate Resistance | R_g | f = 1 MHz | | 6.1 | 9.2 | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 20 | |
| Rise Time | t _r | $V_{DD} = -50 \text{ V}, R_L = 25 \Omega$ | | 55 | 95 | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong -3 \text{ A}, V_{GEN} = -6 \text{ V}, R_g = 1 \Omega$ | | 20 | 40 | 1 |
| Fall Time | t _f | | | 15 | 30 | no |
| Turn-On Delay Time | t _{d(on)} | | | 11 | 18 | ns |
| Rise Time | t _r | $V_{DD} = -50 \text{ V}, R_{L} = 25 \Omega$ | | 18 | 32 | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong -3 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$ | | 32 | 58 | |
| Fall Time | t _f | | | 20 | 35 | |
| Drain-Source Body Diode Characteris | tics | | | | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 13 | _ |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 15 | A |
| Body Diode Voltage | V_{SD} | I _S = - 3 A | | - 0.8 | - 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 65 | 90 | ns |
| Body Diode Reverse Recovery Charge | very Charge O | | | 180 | 270 | nC |
| Reverse Recovery Fall Time | t _a | $I_F = -3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$ | | 45 | | |
| Reverse Recovery Rise Time | t _b | \dashv | | 20 | | ns |

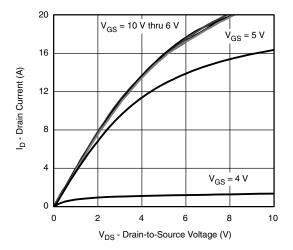
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

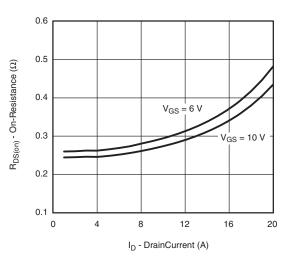
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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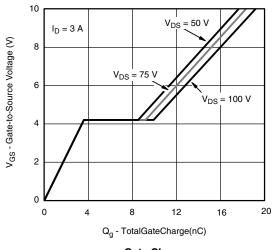




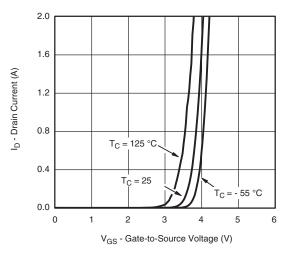
Output Characteristics



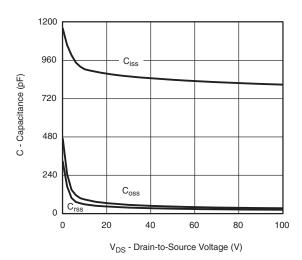
On-Resistance vs. Drain Current and Gate Voltage



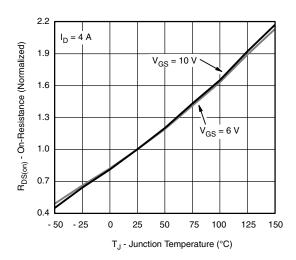
Gate Charge



Transfer Characteristics

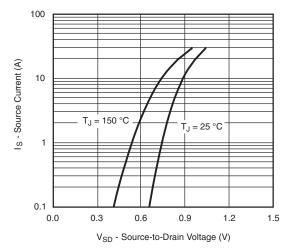


Capacitance

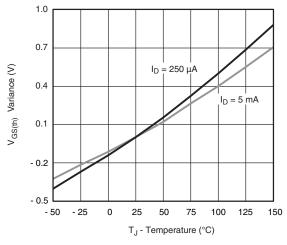


On-Resistance vs. Junction Temperature

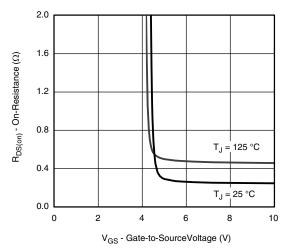




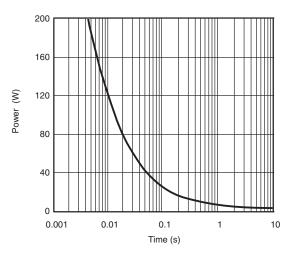
Source-Drain Diode Forward Voltage



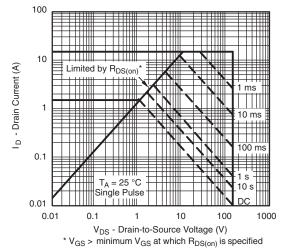
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



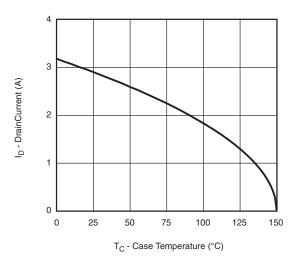
Single Pulse Power, Junction-to-Ambient



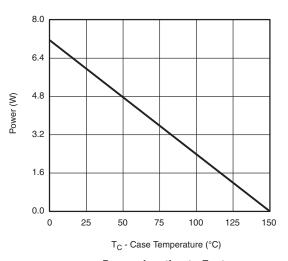
Safe Operating Area, Junction-to-Ambient

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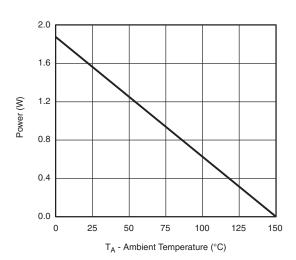




Current Derating*





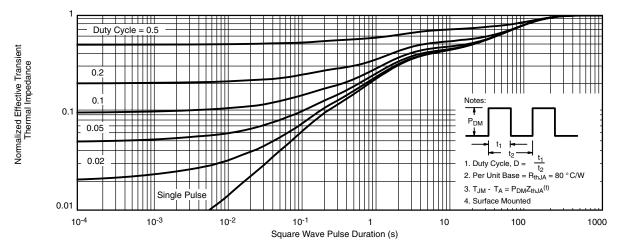


Power, Junction-to-Ambient

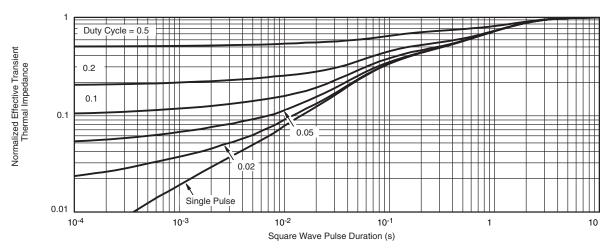
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^{*} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

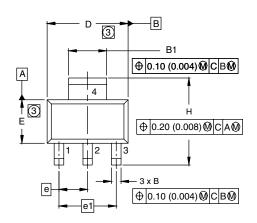


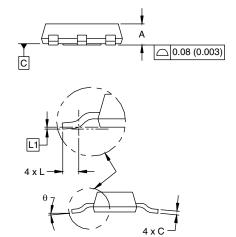
Normalized Thermal Transient Impedance, Junction-to-Foot

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SOT-223 (HIGH VOLTAGE)





| DIM. | MILLI | MILLIMETERS | | INCHES | |
|------|-----------|-------------|--------|--------|--|
| | MIN. | MAX. | MIN. | MAX. | |
| Α | 1.55 | 1.80 | 0.061 | 0.071 | |
| В | 0.65 | 0.85 | 0.026 | 0.033 | |
| B1 | 2.95 | 3.15 | 0.116 | 0.124 | |
| С | 0.25 | 0.35 | 0.010 | 0.014 | |
| D | 6.30 | 6.70 | 0.248 | 0.264 | |
| E | 3.30 | 3.70 | 0.130 | 0.146 | |
| е | 2.30 BSC | | 0.090 | 5 BSC | |
| e1 | 4.60 | 4.60 BSC | | BSC | |
| Н | 6.71 | 7.29 | 0.264 | 0.287 | |
| L | 0.91 | - | 0.036 | = | |
| L1 | 0.061 BSC | | 0.0024 | 4 BSC | |
| θ | - | 10' | - | 10' | |

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

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